

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MINGYU WAN	05/26/2017
ZISHENG CAO	05/29/2017
FANG LIU	05/23/2017
RECEIVING PARTY DATA	
Name:	SZ DJI TECHNOLOGY CO., LTD
Street Address:	17/F, WEST WING, SKYWORTH SEMICONDUCTOR DESIGN BUILDING
Internal Address:	NO. 18 GAOXIN SOUTH 4TH AVENUE, NANSHAN DISTRICT
City:	SHENZHEN CITY
State/Country:	CHINA
Postal Code:	518057
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15615705
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	45236-769.301
NAME OF SUBMITTER:	ANNETTE PALLADINO
SIGNATURE:	/annette palladino/
DATE SIGNED:	06/06/2017
Total Attachments: 1	
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PATENT ASSIGNMENT

Docket Number 45236-769.301

WHEREAS, the undersigned:

- | | | |
|-----------------------------------|-----------------------------------|--------------------------------|
| 1. Mingyu WANG
Shenzhen, China | 2. Zisheng CAO
Shenzhen, China | 3. Fang LIU
Shenzhen, China |
|-----------------------------------|-----------------------------------|--------------------------------|

(hereinafter "Inventor(s)"), have invented certain new and useful improvements in

IMAGING SYSTEM

for which Application No. filed herewith; which is a continuation application of International Application No. PCT/CN2015/076998 which was filed on April 20, 2015 in the State Intellectual Property Office of the P.R.C. (China Receiving Office) of the Patent Cooperation Treaty.

(hereinafter, "Application(s)"). The term "Application(s)" also includes all patent applications that share or claim priority to or from the above application(s).

WHEREAS, SZ DJI TECHNOLOGY CO., LTD., a corporation of China, having a place of business at 17/F, West Wing, Skyworth Semiconductor Design Building, No. 18 Gaoxin South 4th Avenue, Nanshan District, Shenzhen City, Guangdong 518057, China, (hereinafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to said Application(s), and the inventions disclosed therein, and in and to all embodiments of the inventions, heretofore conceived, made or discovered, whether jointly or severally, by said Inventor(s) (hereinafter collectively referred to as "Inventions"), and in and to all claims for past, present and future patents, inventor's certificates and other forms of protection thereon granted in the United States, foreign countries, or under any international convention, agreement, protocol, or treaty, including those filed under the Paris Convention for the Protection of Industrial Property, The Patent Cooperation Treaty or otherwise (hereinafter "Patent(s)").

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor(s) to have been received in full from said Assignee:

1. Said Inventor(s) do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said Inventions; (b) in and to said Applications, including the right to claim priority to and from said Application(s); (c) in and to each and every application that is a divisional, substitution, continuation, or continuation-in-part of any of said Application(s); (d) in and to said Patent(s) and each and every patent issuing or reissuing from any of the foregoing; (e) in and to each and every reissue, reexamination, renewal or extension of any kind of any of the foregoing; (f) in and to each and every patent and application filed outside the United States and corresponding to any of the foregoing; and (g) in and to all claims for past, present and future infringement of the Patent(s), including all rights to sue for and to receive and recover for Assignee's own use all past, present, and future lost profits, royalties, and damages of whatever nature recoverable from an infringement of the Patent(s).

2. Said Inventor(s) hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States, foreign countries, or under any international convention, agreement, protocol, or treaty. Such cooperation by said Inventor(s) shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any applications covering said Inventions; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Inventions; (d) for filing and prosecuting applications for reissuance of any said Patent(s); (e) for interference or other priority proceedings involving said Inventions; and (f) for legal proceedings involving said Inventions and any applications therefor and any Patent(s) granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that reasonable expenses incurred by said Inventor(s) in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor(s), their respective heirs, legal representatives and assigns.

4. Said Inventor(s) hereby warrant, represent and covenant that said Inventor(s) have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

5. Said Inventor(s) hereby request that any Patent(s) issuing in the United States, foreign countries, or under any international convention, agreement, protocol, or treaty, be issued in the name of the Assignee, or its successors and assigns, for the sole use of said Assignee, its successors, legal representatives and assigns.

6. This instrument will be interpreted and construed in accordance with the laws of the State of California, without regard to conflict of law principles. If any provision of this instrument is found to be illegal or unenforceable, the other provisions shall remain effective and enforceable to the greatest extent permitted by law. This instrument may be executed in counterparts, each of which is deemed an original, but all of which together constitute one and the same agreement.

IN WITNESS WHEREOF, said Inventor(s) have executed and delivered this instrument to said Assignee as of the dates written below:

Date: <u>2017.5.24</u>	<u>Mingyu Wang</u>	Date: <u>5/29/2017</u>	<u>Zisheng Cao</u>
	Mingyu WANG		Zisheng CAO
Date: <u>5/23/2017</u>	<u>Fang Liu</u>		
	Fang LIU		